# **MA3X716** (MA716)

### Silicon epitaxial planar type

For switching

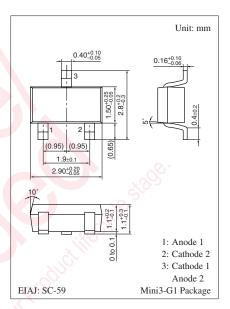
For wave detection

#### ■ Features

- Two MA3X704A (MA704A) is contained in one package (series connection)
- Low forward voltage V<sub>F</sub>, optimum for low voltage rectification
- Optimum for high frequency rectification because of its short reverse recovery time (t<sub>rr</sub>)

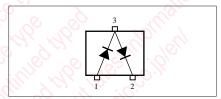
#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage		$V_R$	30	V
Maximum peak reverse voltage		V <sub>RM</sub>	30	V
Peak forward current	Single	$I_{FM}$	150	mA
	Series		110	
Forward current	Single	$I_{F}$	30	mA
	Series		20	101
Junction temperature		T <sub>j</sub>	125	C°C
Storage temperature		T <sub>stg</sub>	-55 to +125	°C



Marking Symbol: M1U

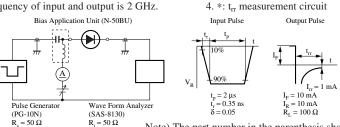
#### Internal Connection



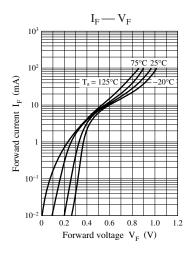
### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

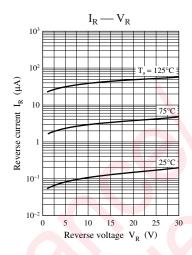
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{F1}$	I <sub>F</sub> = 1 mA	'VS),		0.4	V
	$V_{F2}$	$I_F = 30 \text{ mA}$			1.0	
Reverse current	$I_R$	$V_R = 30 \text{ V}$			1	μΑ
Terminal capacitance	C <sub>t</sub>	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$		1.0		ns
illi		$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency	η	$V_{IN} = 3 V_{(peak)}$ , $f = 30 MHz$		65		%
		$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

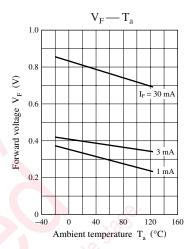
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 2 GHz.

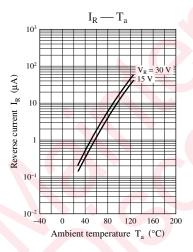


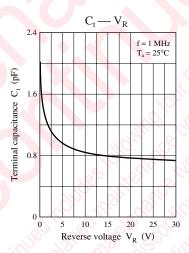
Note) The part number in the parenthesis shows conventional part number.











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